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(TEST STANDARD: JIS C 60068) RESISTANCE TO 1)REFLOW SOLDERING: NO DEFORMATION OF CASE OF SOLDERING HEAT P.260°CMAX REFLOW TMP: 220°CMIN FOR 60sec 2) SOLDERING IRONS: 360°C MAX. FOR 5 sec. SOLDERABILITY SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec. SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED. COUNT DESCRIPTION OF REVISIONS DESIGNED CHECKED C'"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB. C"THE RATED CURRENT APPLIES TO PER CONTACT. Unless otherwise specified, refer to JIS-C-5402. NOTE QT:Qualification Test AT:Assurance Test X:Applicable Test DRAWING NO. ELC4-334390-C SPECIFICATION SHEET PART NO. FX18-40S-0. 8SV20 HIROSE ELECTRIC CO., LTD. CODE NO. CL579-0030-0-000	SULI	FUR DIC	IXIDE					NO HEAVY CORROSION.				×	-	
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